

FIB (Nova 600)

집속이온빔

Dual beam Focused Ion Beam has multitude of capabilities including high resolution electron imaging, ion imaging, nano device fabrication and material deposition. Simultaneous patterning and imaging is possible with nm resolution for both imaging and machining. Using software control, digital pattern can be directly applied and unattended operation with high repeatability can be employed for TEM sample preparation.

Model

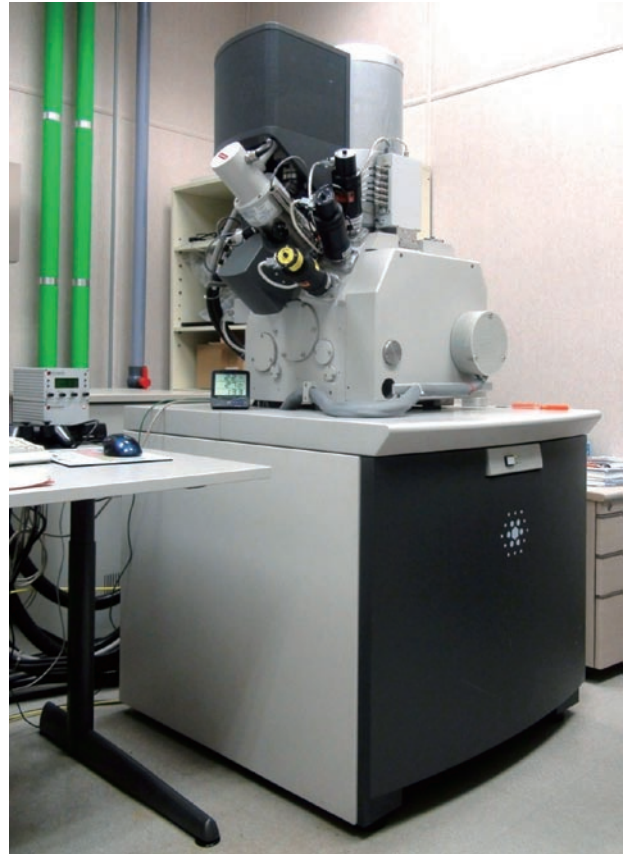
FEI (Nova 600 NanoLab)

Specifications

- Accelerating voltage : 5 ~ 30 kV
- Image resolution : 1.1 nm (15 kV)
- Magnification : 25 ~ 1,000,000 X
- Stage : 6", Piezo linear motor control

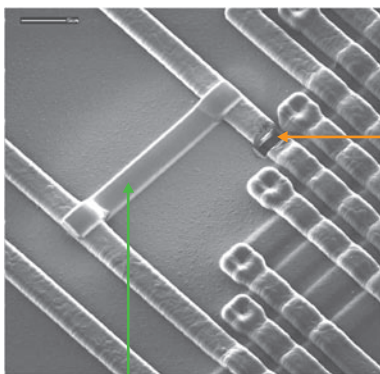
Applications

- SE / BSE / Ion image
- Slice & View
- Nano patlarning



Location L5115A Tel.02-958-5985

Ion beam machining



Add material
Deposition (Pt)

Form an image
Electron & ion beam

Remove material
Milling (Ga ion)

TEM sample preparation

